

JOURNAL ARTICLE PUBLICATION STATEMENT

Letter Of Accepted (LoA)

Number : 995/JITIE/Vol1/No2/2025

Dear.

ARIN NADHIROH ,AYENDE

Thank you for submitting your best article to be published on **Journal of Interdisciplinary Technologies, Informatics, and Engineering (JITIE)** with the title:

**"ANALISA PENGARUH THERMAL PENGELASAN METODE SMAW
TERHADAP DEFORMASI DENGAN VARIASI ELEKTRODA E7016
DAN E7018 PADA PELAT A36 UNTUK BBM"**

Based on the results of the review and the decision of the editorial team, the article is declared **ACCEPTED** for publication in the **Journal of Interdisciplinary Technologies, Informatics, and Engineering (JITIE)** edition **Volume 1 Number 2**

Thus we submit this letter of information to be used as it should be, we express our gratitude.

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Palembang, 01 November 2025
Editor In Chief



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Muhammad Rizky, M.Ed.

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Jl. Sei Sahang, N0. 5296, Kec. IB 1, Kel. Lorok Pakjo, Kota Palembang
0895404313613 / 081274887803
admin@jurnalpustakacendekia.com